

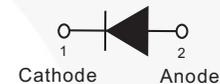


August 2015

SSA24 Surface Mount Schottky Barrier Rectifier

Features

- UL Flammability 94V-0 Classification
- MSL 1
- RoHS Compliant / Green Mold Compound
- Industrial Device Qualified per AEC-Q101 Standards.
* see authorized use policy



Ordering Information

Part Number	Top Mark	Package	Packing Method
SSA24	SSA24	DO-214AC (SMA)	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{RRM}	Recurrent Peak Reverse Voltage	40	V
V_{RMS}	RMS Voltage	28	V
V_{DC}	DC Blocking Voltage	40	V
$I_{F(AV)}$	Average Forward Current at $T_L = 75^\circ\text{C}$	2	A
I_{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	50	A
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

SSA24 — Surface Mount Schottky Barrier Rectifier

Thermal Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
Ψ_{JL}	Typical Thermal Characteristics, Junction-to-Lead ⁽¹⁾	20	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient ⁽¹⁾	75	$^\circ\text{C}/\text{W}$

Note:

1. Mounted on P.C.Board with 8mm^2 (0.013 mm thick) copper pad areas.

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Forward Voltage ⁽²⁾	$I_F = 2.0\text{ A}$			0.5	V
I_R	DC Reverse Current	$V_R = 40\text{ V}$			0.2	mA
		$V_R = 40\text{ V}, T_A = 100^\circ\text{C}$			20	
T_{rr}	Reverse Recovery Time	$I_F = 0.5\text{ A}, I_R = 1\text{ A}, I_{rr} = 0.25\text{ A}$		9.84		ns

Note:

2. Pulse test with Pulse width = $300\ \mu\text{s}$, 1% duty cycle.

Typical Performance Characteristics

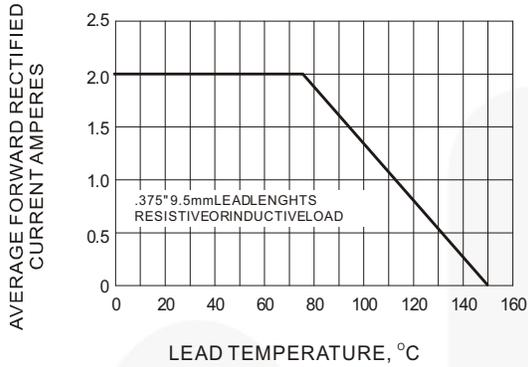


Figure 1. Forward Current Derating Curve

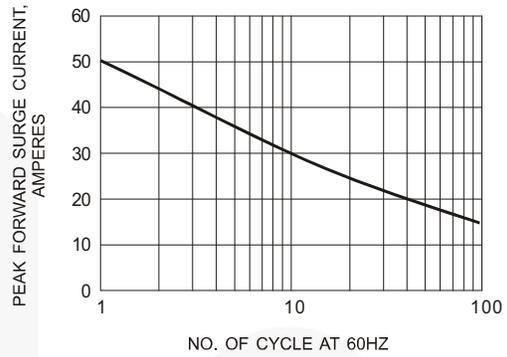


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

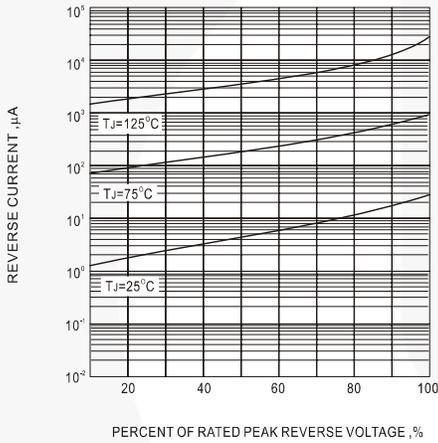


Figure 3. Typical Reverse Characteristic

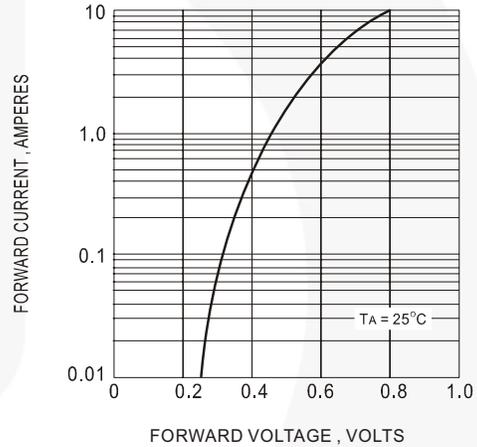


Figure 4. Typical Instantaneous Forward Characteristics

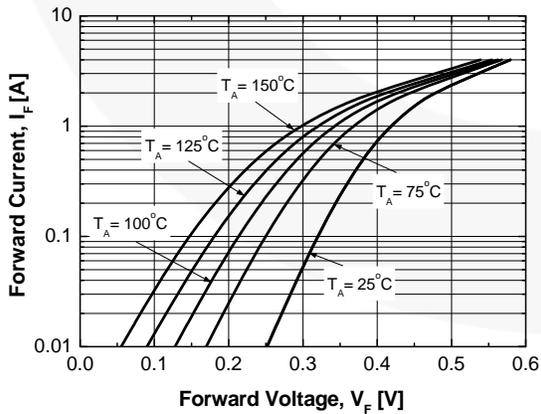


Figure 5. Typical Forward Characteristics

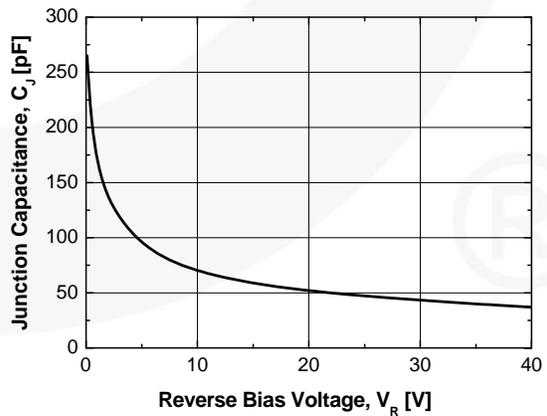
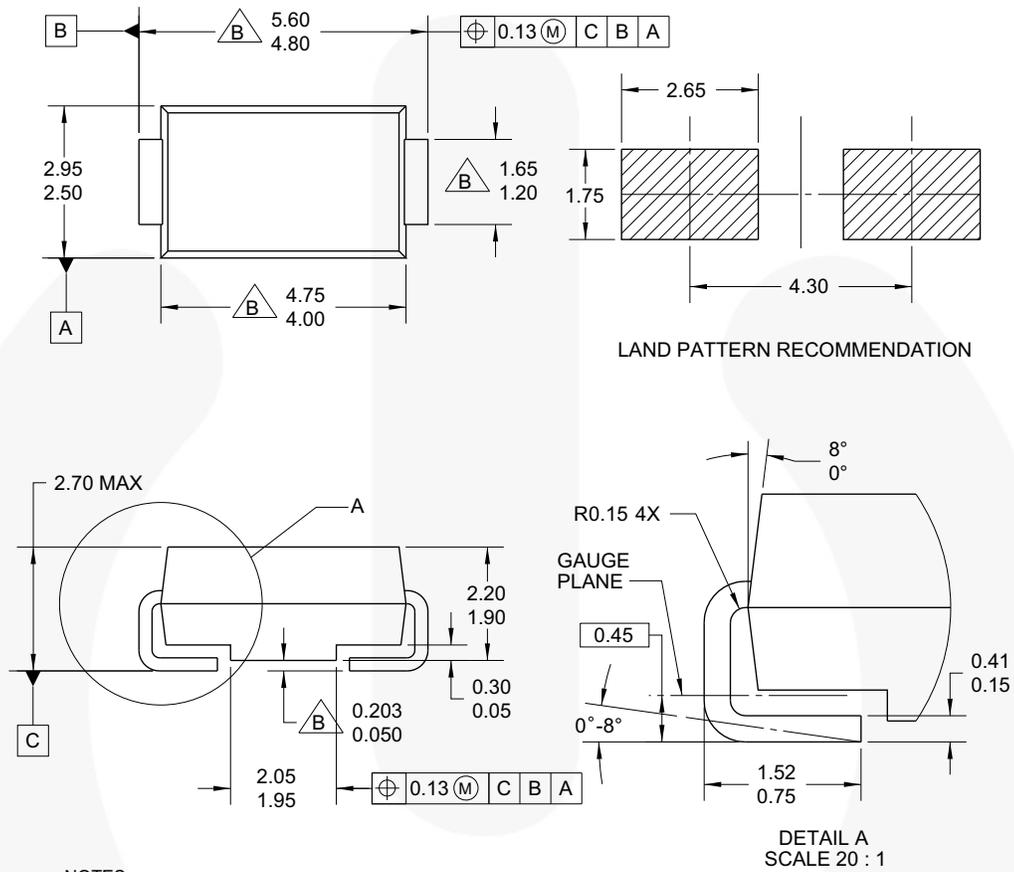


Figure 6. Typical Junction Capacitance

Physical Dimensions



NOTES:

- A. EXCEPT WHERE NOTED CONFORMS TO JEDEC DO214 VARIATION AC.
- B. DOES NOT COMPLY JEDEC STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. LAND PATTERN STD. DIOM5025X231M.
- G. DRAWING FILE NAME: DO214ACREV1

Figure 7. 2-LEAD, SMA, JEDEC DO-214, VARIATION AC



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